



BSI Standards Publication

Fibre optic active components and devices — Test and measurement procedures

Part 6: Universal mezzanine boards for test and measurement of photonic devices

National foreword

This British Standard is the UK implementation of EN IEC 62150-6:2022. It is identical to IEC 62150-6:2022.

The UK participation in its preparation was entrusted to Technical Committee GEL/86/3, Fibre optic systems and active devices.

A list of organizations represented on this committee can be obtained on request to its committee manager.

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English Version

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(IEC 62150-6:2022)

Composants et dispositifs actifs fibroniques - Procédures
d'essais de base et de mesures - Partie 6: Cartes
mezzanines universelles pour les essais et les mesures des
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(IEC 62150-6:2022)

Aktive Lichtwellenleiter-Bauteile und -Bauelemente - Prüf-
und Messverfahren - Teil 6: Universelle Mezzanine Platinen
zur Prüfung und Messung von photonischen Baugruppen
(IEC 62150-6:2022)

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European Committee for Electrotechnical Standardization
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European foreword

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Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60050-731	-	International Electrotechnical Vocabulary - Part 731: Optical fibre communication	-	-
IEC 62150-1	-	Fibre optic active components and devices - Test and measurement procedures - Part 1: General and guidance	EN 62150-1	-
IEC TR 63072-1	-	Photonic integrated circuits - Part 1: Introduction and roadmap for standardization	-	-

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

**FIBRE OPTIC ACTIVE COMPONENTS AND DEVICES –
TEST AND MEASUREMENT PROCEDURES –****Part 6: Universal mezzanine boards for test and
measurement of photonic devices**

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The language used for the development of this International Standard is English.

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